

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JONG LEE	12/31/2018
SABIN EFTIMIE	12/31/2018
RECEIVING PARTY DATA	
Name:	DIALOG SEMICONDUCTOR (UK) LIMITED
Street Address:	TOWER BRIDGE HOUSE
Internal Address:	ST. KATHARINE'S WAY
City:	LONDON
State/Country:	UNITED KINGDOM
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16237168
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ATTORNEY DOCKET NUMBER:	DS18-075S
NAME OF SUBMITTER:	STEPHEN B ACKERMAN
SIGNATURE:	/Stephen B Ackerman/
DATE SIGNED:	02/27/2019
Total Attachments: 2	
source=DS18-075S_Assignment#page1.tif	
source=DS18-075S_Assignment#page2.tif	

For U.S. and/or Foreign Rights
 For Application or U.S. Patent
 By Inventor(s) or Present Owner

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNOR:

Jong Lee
 Type or print name of ASSIGNOR
2560 Mission College Blvd. Suite 110
 Mailing Address - Street
Santa Clara, CA 95054 USA
 City, State, Country, Zip
USA
 Nationality

Sabin Eftimie
 Type or print name of ASSIGNOR
2560 Mission College Blvd. Suite 110
 Mailing Address - Street
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ROMANIAN
 Nationality

hereby sells, assigns and transfers to

ASSIGNEE:

Dialog Semiconductor (UK) Limited
Tower Bridge House
St. Katharine's Way
London E1W 1AA
United Kingdom
 Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

the entire right, title and interest
 an undivided _____ percent (___%) interest for the United States and its territorial possessions

(check the following box if foreign rights are also to be assigned)

and in all foreign countries

in and to any and all improvements which are disclosed in the invention entitled:

Protection of Charge Pump Circuits from High Input Voltages

DS18-075S

and which is found in

- (a) U.S. patent application executed on even date herewith
- (b) U.S. patent application executed on _____
- (c) U.S. application serial no. _____ filed on _____
- (d) U.S. patent no. _____ issued _____
(also check (e) if foreign application(s) is also being assigned)
- (e) and any legal equivalent thereof in a foreign country, including the right to claim priority

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute, thereof, and as to letters patent any re-issue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I / We have signed

WARNING Date of signing must be the same as the date of execution of the application if item (a) was checked above.

Jong J. Lee
Signature of ASSIGNOR

12/31/2018
Date of Signing

[Signature]
Signature of ASSIGNOR

12/31/2018
Date of Signing